

Features

- Planar Die Construction
- 500mW Power Dissipation
- General Purpose, Medium Current
- Ideally Suited for Automated Assembly Processes
- **Lead, Halogen and Antimony Free, RoHS Compliant**
- **"Green" Device (Note 4)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOD-123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)



Top View

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Forward Voltage (Note 3) @ $I_F = 10\text{mA}$	V_F	0.9	V

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1) @ $T_L = 75^\circ\text{C}$	P_D	500	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	$R_{\theta JA}$	350	$^\circ\text{C/W}$
Thermal Resistance, Junction to Lead (Note 2)	$R_{\theta JL}$	150	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Type Number	Type Code	Zener Voltage Range (Note 3)			Test Current	Maximum Zener Impedance (Note 5)		Maximum Reverse Leakage Current (Note 3)	
		$V_Z @ I_{ZT}$				I_{ZT}	$Z_{ZT} @ I_{ZT}$	$Z_{ZK} @ I_{ZK} = 0.25\text{mA}$	I_R
		Nom (V)	Min (V)	Max (V)	mA				
MMSZ5263B	M8	56	53.20	58.80	2.2	150	1300	0.1	43

- Notes:
1. Device mounted on FR-4 substrate, single-sided, PC boards, with minimum recommended pad layout.
 2. Thermal Resistance measurement obtained via infrared scan method.
 3. Short duration pulse test used to minimize self-heating effect.
 4. No purposefully added lead. Halogen and Antimony Free.
 5. $f = 1\text{KHz}$.

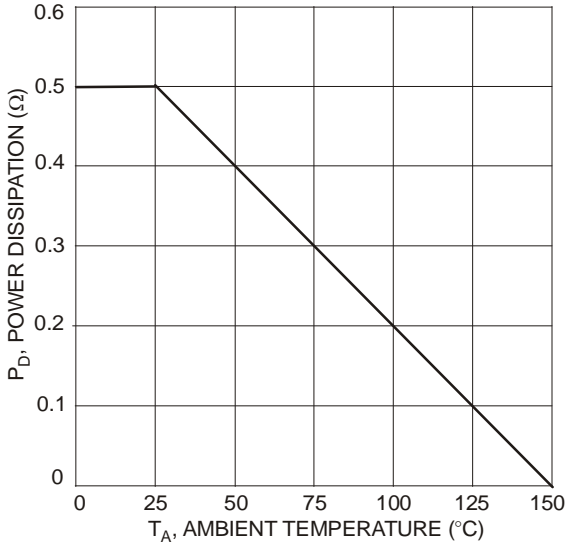


Fig. 1 Power Derating Curve

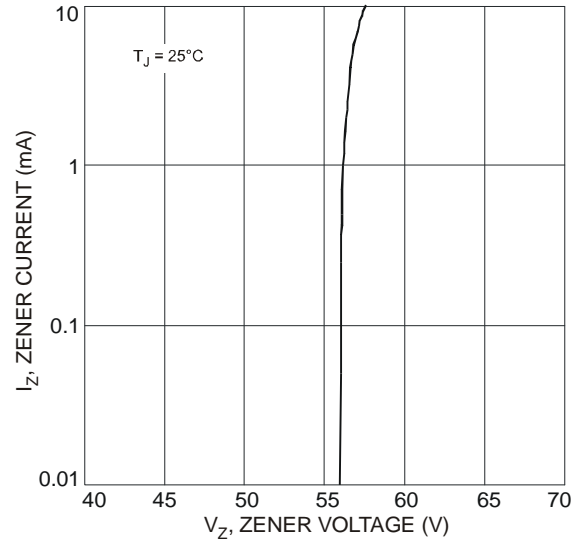


Fig. 2 Typical Zener Breakdown Characteristics

Ordering Information (Note 5)

Part Number	Packaging	Shipping
MMSZ5263B-7-F	SOD-123	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



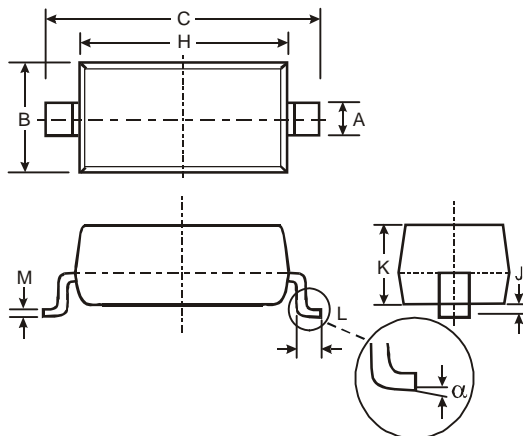
M8 = Product Type Marking Code
(See Electrical Characteristics Table)
YM = Date Code Marking
Y = Year (ex: W = 2009)
M = Month (ex: 9 = September)

Date Code Key

Year	2009	2010	2011	2012	2013	2014	2015
Code	W	X	Y	Z	A	B	C

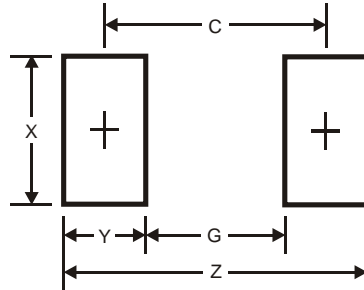
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Package Outline Dimensions



SOD-123		
Dim	Min	Max
A	0.55 Typ	
B	1.40	1.70
C	3.55	3.85
H	2.55	2.85
J	0.00	0.10
K	1.00	1.35
L	0.25	0.40
M	0.10	0.15
α	0	8°
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	4.9
G	2.5
X	0.7
Y	1.2
C	3.7

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